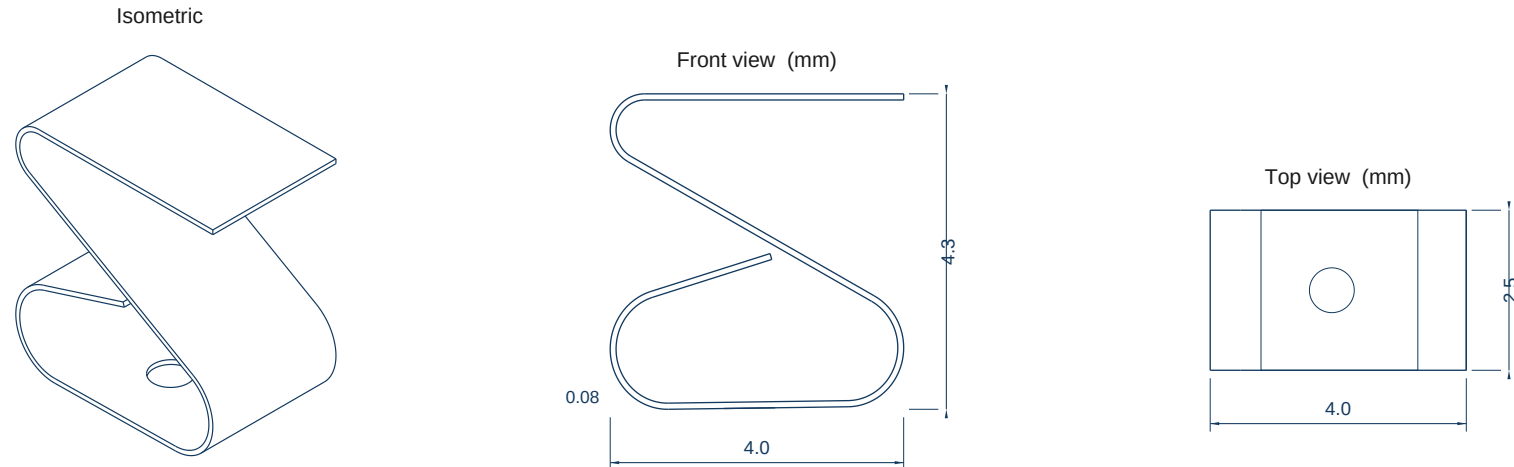




Type 5-01 B501-25040043

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL

VALUE

Thickness	0.08 mm
Width	2.5 mm +/- 0.2
Length	4.0 mm +/- 0.2
Height	4.3 mm +/- 0.2
Form	Z-form: top plate, diagonal web, base plate + return tongue
Base hole	dia 0.70 mm at 1.90 / 1.25 from the corner
Profile source	B501-25040041 solid, height-scaled x1.048 - see note
Material / plating	BeCu, Gold-plated (G)
Volume / mass	3.454 mm ³ 28.8 mg (BeCu)
File format	STEP AP214

PRODUCT DATA

VALUE

Mfr P/N	B501-25040043G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 4.0x2.5x4.3mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-5-01.html